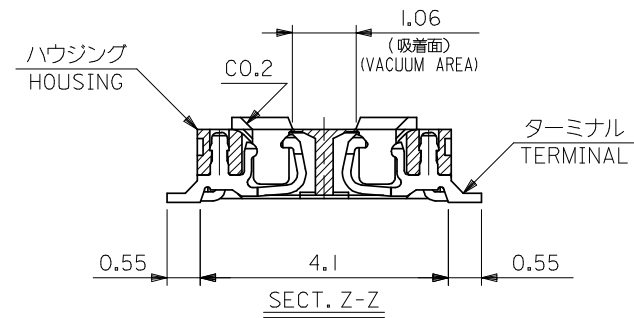
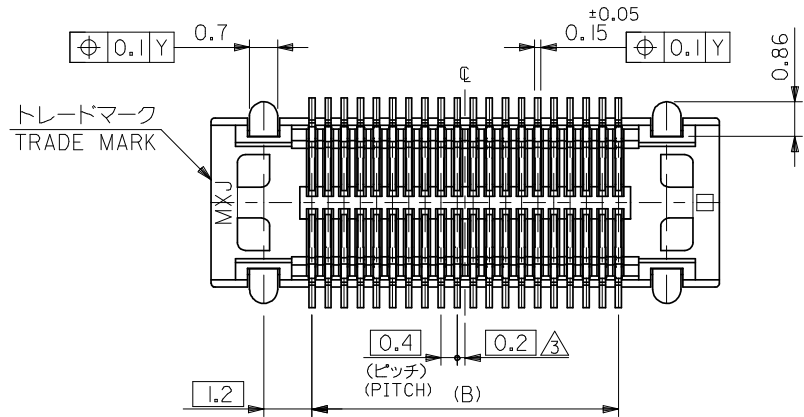
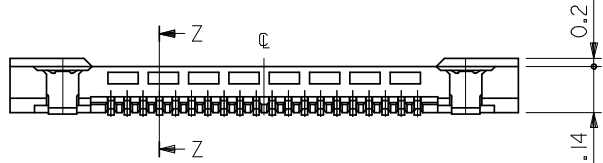
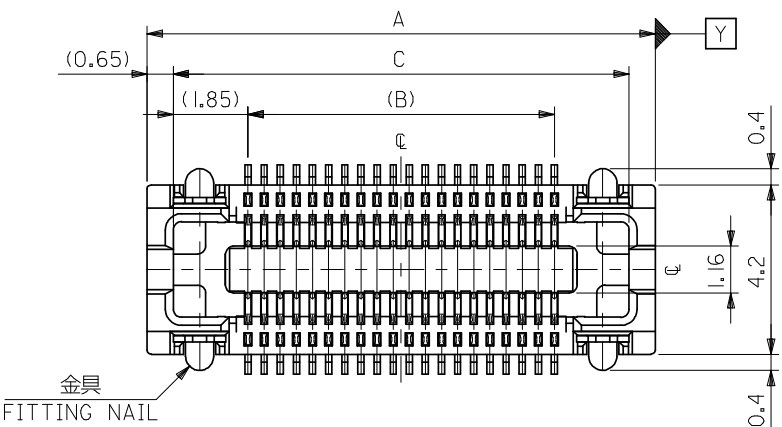


19.3	15.6	20.6	54765-8070	54765-8009	80
17.3	13.6	18.6	-7070	-7009	70
14.1	10.4	15.4	-5470	-5409	54
13.3	9.6	14.6	-5070	-5009	50
12.5	8.8	13.8	-4670	-4609	46
12.1	8.4	13.4	-4470	-4409	44
11.3	7.6	12.6	-4070	-4009	40
9.3	5.6	10.6	-3070	-3009	30
8.1	4.4	9.4	-2470	-2409	24
7.7	4.0	9.0	54765-2270	54765-2209	22
C	B	A	EMBOSSD TAPE PKG. ORDER No. オーダー番号	MATERIAL NO.	CIRCUIT

REVISED
EC NO: J2009-0301
DRWN: MABEI
CHKD: THARUYAMA
APPR: NUKITA

2008/08/27
2008/08/28
2008/08/28

DESCRIPTION
REV

GENERAL TOLERANCES
(UNLESS SPECIFIED)
10 UNDER ±0.2
10 OVER 30 UNDER ±0.25
30 OVER ±0.3
ANGULAR ±3 °
DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
MM ONLY
DRAWN BY
M. NINOMIYA
DATE
'04/02/19
CHECKED BY
K. TOJO
DATE
'04/02/19
APPROVED BY
M. SASAO
DATE
'04/02/19
MATERIAL NO.
SEE TABLE
SIZE
A3

SCALE

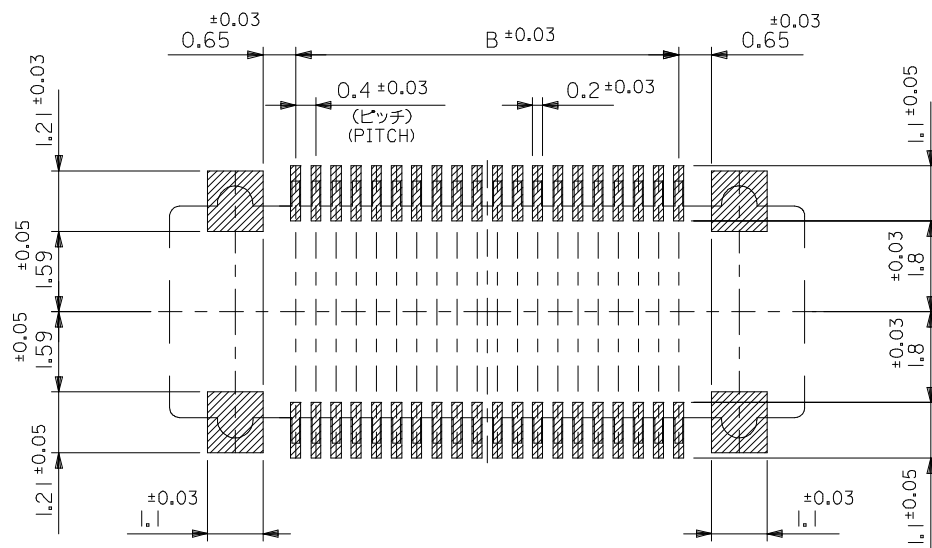
MODEL NO.
54765-***9
DESIGN UNITS
METRIC
THIRD ANGLE
PROJECTION
TITLE
0.4 B-TO-B REC HSG ASSY
WITH GUIDE HGT=1.5 NI
-LEAD FREE-
MOLEX INCORPORATED
DOCUMENT NO.
SD-54765-030
SHEET NO.
1 OF 2

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX
INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

tb_frame_A3_J_ME_S
Rev. E 2006/04/15

987654321

EN-02JA(021)



参考基板レイアウト（マウント面）

P.C.BOARD PATTERN DIMENSION. (REFERENCE)
(MOUNTING AREA)

注記 NOTES

1. 使用材料 MATERIAL

ハウジング: 液晶ポリマー ガラス充填 UL94V-0 (黒)
HOUSING: LIQUID CRYSTAL POLYMER (GLASS FILLED)
UL94V-0 (COLOR: BLACK)

ターミナル：リン青銅 (t=0.15)
 TERMINAL:PHOSPHOR BRONZE (t=0.15)

金具：リン青銅 ($t=0.15$)
FITTING NAIL: PHOSPHOR BRONZE ($t=0.15$)

△2 メッキ仕様 PLATING

ターミナル TERMINAL

金メッキ 0.25マイクロメートル以上 (コンタクト部)
GOLD 0.25MICROMETER MINIMUM (CONTACT AREA)

GOLD 0.4MICROMETER MAXIMUM (TAIL AREA)

下地メッキ：ニッケルメッキ1.5マイクロメートル以上
UNDER PLATING: NICKEL 1.5MICROMETER MINIMUM

*コンタクト部とテール部はニッケルメッキによって分断さ

DIVIDE INTO PARTS THE GOLD PLATING OF THE CONTACT PART AND THE TAIL PART BY THE NICKEL PLATING.

金具 FITTING NAIL

錫メッキ 1マイクロメートル以上
Sn 1 MICROMETER MINIMUM

下地メッキ：ニッケルメッキ 1マイクロメートル以上
UNDER PLATING: NICKEL 1 MICROMETER MINIMUM

△3 (全極数/2) = 偶数の場合に適用。
APPLY FOR (CIRCUIT/2)=EVEN

11. 11. 2014

4. 嵌合相手: 55604シリーズ。
MATE WITH: 55604 SERIES

5. テール平坦度は、0.08以下

テール及び金具の平坦度は、0.1以下

TAIL COPLANARITY TO BE 0.08MAXIMUM.

TAIL AND FITTING NAIL

COPLANARITY TO BE 0.1 MAXIMUM.

6. 本製品は 54765-***3 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 54765-***3.

REVISED	EC NO: J2009-0301	2008/08/27	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	MODEL NO.	54765-***9	THIRD ANGLE PROJECTION
	DRWN:MMABEI	2008/08/28				MM ONLY		---	METRIC			
	CHKD:THARYAWA	2008/08/28		10 UNDER	± ---	M. NINOMIYA	DATE '04/02/19	TITLE 0.4 B-TO-B REC HSG ASSY WITH GUIDE HGT-1.5 NI -LEAD FREE-				
	APPR:NUKI TA	2008/08/28		10 OVER 30 UNDER	± ---	CHECKED BY	DATE '04/02/19					
				30 OVER	± ---	APPROVED BY	DATE '04/02/19		 MOLEX INCORPORATED			
REV	A		ANGULAR	± --- °	MATERIAL NO.		DOCUMENT NO.		SHEET NO.			
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	SEE SHEET 1		SD-54765-030		2 OF 2		
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION												

DWG. NO.
SD-54765-031

F

D

V

C

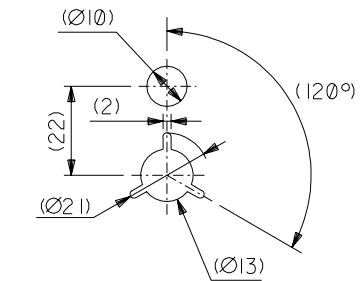
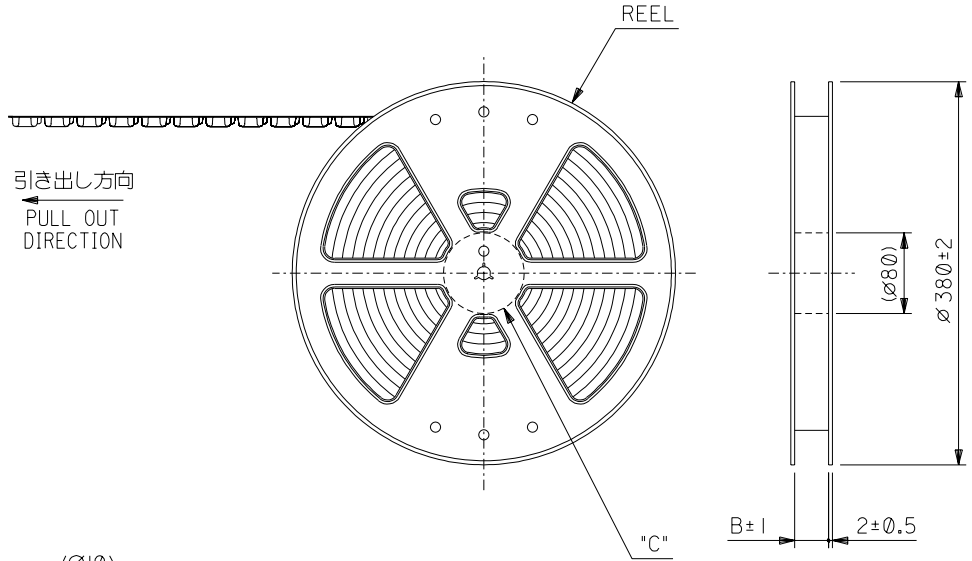
B

DO NOT SCALE DRAWING

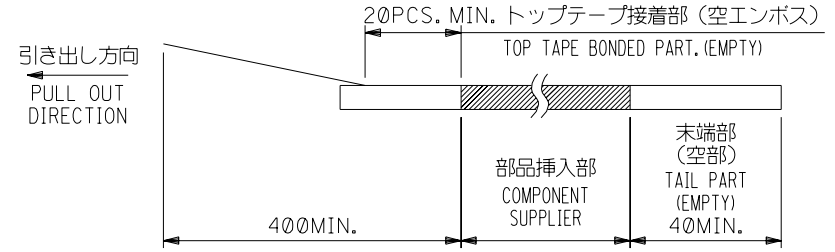
8 7 6 5 4 3 2 1

注記 NOTES

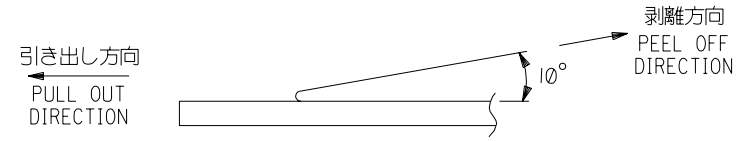
- 製品詳細寸法については図面 SD-54765-026 を参照下さい。
RE DETAILED DIMENSION, SEE SD-54765-026
- 梱包数量：2500個/リール
NUMBER OF CONNECTORS : 2500PCS/REEL
- リードテープ長さ LEAD TAPE LENGTH



DETAIL "C"



- トップテープの剥離強度：0.1N ～ 1.3N(10gf ～ 130gf)
(剥離方向は下図参照)
尚、本規格値は出荷時に適用。(但し、輸送時に剥離が発生しないこと。)
PEELING OFF FORCE OF TOP TAPE : 0.1N ～ 1.3N(10gf ～ 130gf)
(PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT.
PEEL OFF SHOULD NOT BE ALLOWED , DURING TRANSPORTATION.



- 材料 MATERIAL
キャリアテープ (CARRIER TAPE)：ポリプロピレン (POLYPROPYLENE)
トップテープ (TOPTAPE)：PET , PE , PEF
リール (REEL)：ポリスチレン (PS) <リサイクル材を含む>
POLYSTYRENE (PS) <RECYCLE MATERIAL CONTAINED>
- 本製品は 54765-***4 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 54765-***4.

EC NO. DRWN: CHK: APPR:			EC NO. DRWN: CHK: APPR:			EC NO. DRWN: CHK: APPR:			EC NO. DRWN: CHK: APPR:			RELEASED '04/02/19 EC NO. J2004-2532 DRWN: M.NINOMIYA CHK: K.TOJO APPR: M.SASAO			DESCRIPTION			MATERIAL 材料 注記参照 SEE NOTES			GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差			SCALE //		DESIGN UNITS mm INCH		MODEL NO. 54765-***0		DIMENSIONS: THIRD ANGLE PROJECTION mm INCH mm ONLY			SHT REV	
															FINISH 仕上り			10 UNDER 未満			±0.2		DRAWN BY & DATE M.NINOMIYA '04/02/19			TITLE: 0.4 B-To-B Rec Assy W/Gde (Hgt=1.5) [Ni Barrier] Embstp Pkg -LEAD FREE-								
																		10 OVER 30 UNDER 以上 未満			±0.25		CHECKED BY & DATE K.TOJO '04/02/19											
																		30 OVER 以上			±0.3		APPROVED BY & DATE M.SASAO '04/02/19			MOLEX INCORPORATED								
															WIRE RANGE 適用電線範囲						ANGLE 角度			±3°									CAD FILENAME SD-54765-031.S01	
															INS. RANGE 被覆外径						THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.										SIZE B			

SD-54765-031.S01

DWG. NO.
SD-54765-031

F

D

C

B

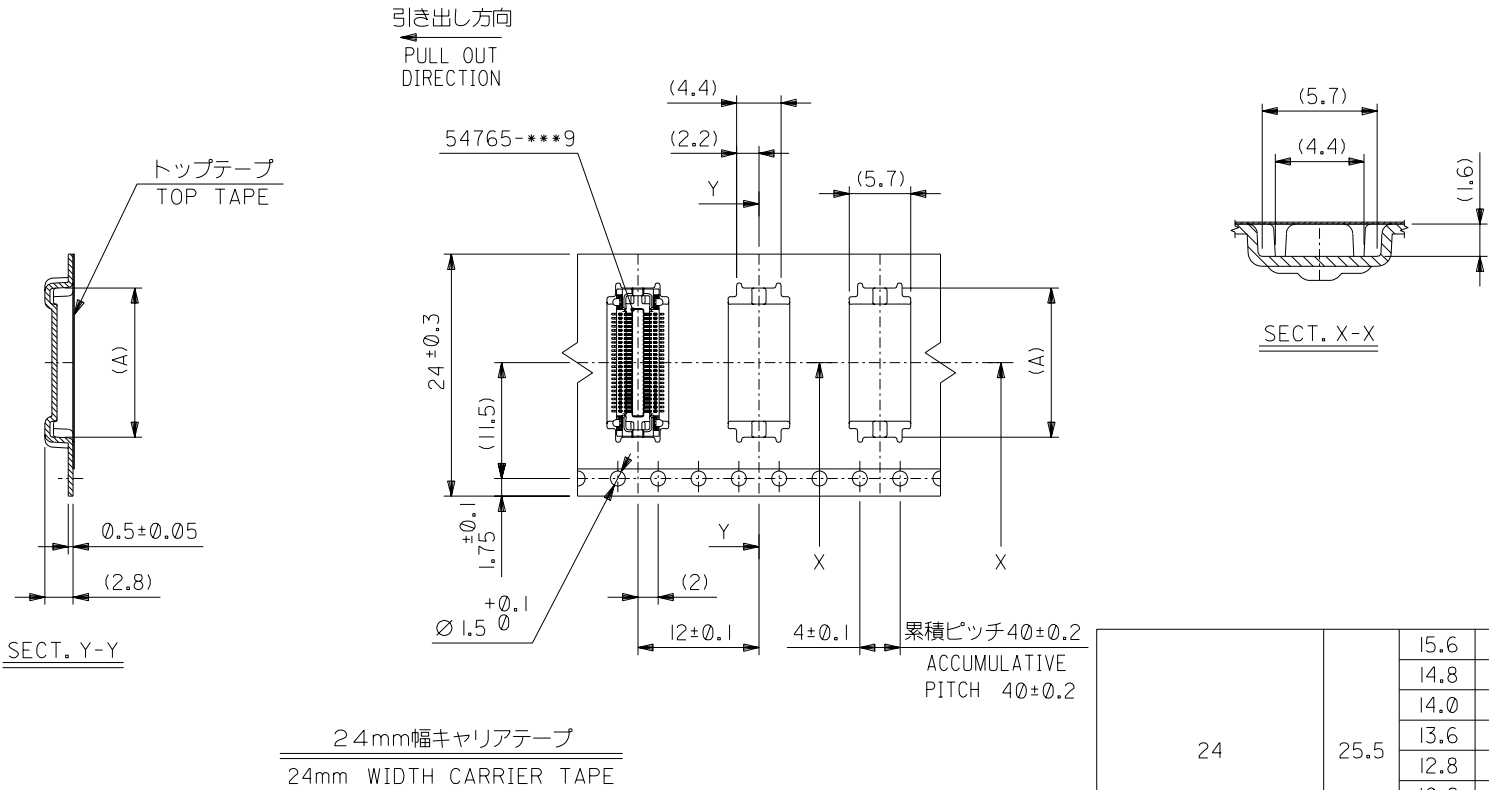
DO NOT SCALE DRAWING

EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	RELEASED '04/02/19 EC NO. J2004-2532 DRWN: M.NINOMIYA CHK: K.TOJO APPR: M.SASAO
					REV

MATERIAL 材料	注記参照 SEE NOTES
FINISH 仕上げ	//
WIRE RANGE 適用電線範囲	//
INS. RANGE 被覆外径	//

GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差	SCALE //	DESIGN UNITS ☒ mm ☐ INCH	DRAWN BY & DATE M.NINOMIYA '04/02/19	CHECKED BY & DATE K.TOJO '04/02/19	APPROVED BY & DATE M.SASAO '04/02/19	CAD FILENAME SD-54765-031.S02
10 UNDER 未満	±0.2					
10 OVER 以上	±0.25					
30 UNDER 未満	±0.3					
30 OVER 以上	±3°					
ANGLE 角度						

MODEL NO. 54765-***0	DIMENSIONS: ☐ mm ☐ INCH ☒ mm ONLY	SHT 2	REV OF 3
TITLE: 0.4 B-To-B Rec Assy W/Gde (Hgt=1.5) [Ni Barrier] Embstp Pkg -LEAD FREE-			
MOLEX INCORPORATED			
MATERIAL NO. SEE CHART	DRAWING NO. SD-54765-031	SHEET NO. 2 OF 3	
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.			
SIZE B			



24mm幅キャリアテープ
24mm WIDTH CARRIER TAPE

24	25.5	15.6	54765-5470	54
		14.8	54765-5070	50
		14.0	54765-4670	46
		13.6	54765-4470	44
		12.8	54765-4070	40
		10.8	54765-3070	30
		9.6	54765-2470	24
		9.2	54765-2270	22
キャリアテープ幅 CARRIER TAPE WIDTH	B	(A)	MATERIAL NO.	極数 CIRCUIT

DWG. NO.
SD-54765-031

F

D

V

C

B

DO NOT SCALE DRAWING

8 7 6 5 4 3 2 1

F

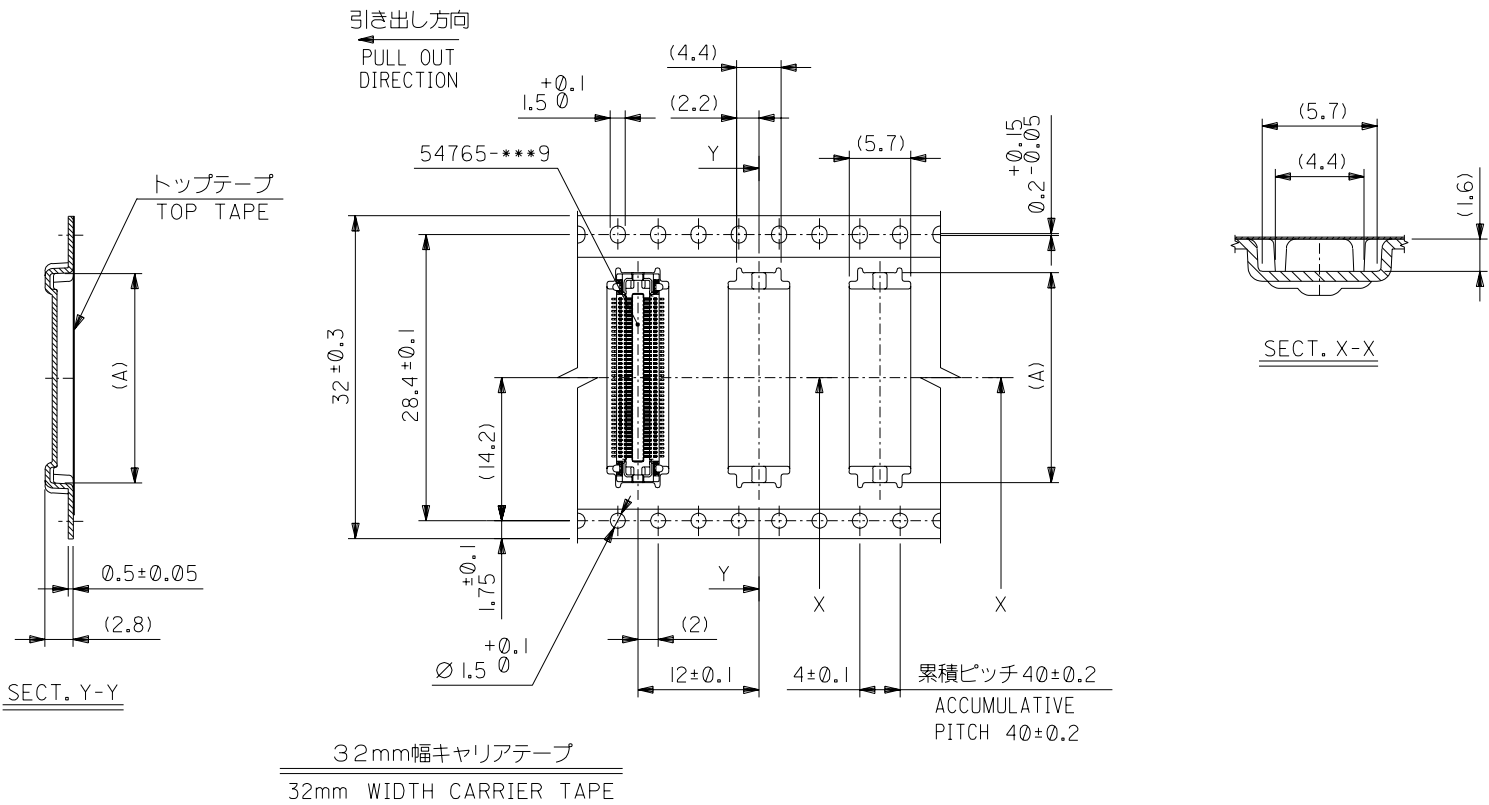
E

D

C

B

SD-54765-031.S03



32	33.5	20.8	54765-8070	80
		18.8	54765-7070	70
キャリアテープ幅 CARRIER TAPE WIDTH		B	(A)	MATERIAL NO.
				極数 CIRCUIT

EC NO. DRWN: CHK: APPR:			EC NO. DRWN: CHK: APPR:			EC NO. DRWN: CHK: APPR:			EC NO. DRWN: CHK: APPR:			RELEASED '04/02/19 EC NO. J2004-2532 DRWN: M.NINOMIYA CHK: K.TOJO APPR: M.SASAO			DESCRIPTION REV	MATERIAL 材料 注記参照 SEE NOTES			GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差			SCALE //		DESIGN UNITS ☒ mm ☐ INCH		THIRD ANGLE PROJECTION 		☐ mm INCH ☐ mm INCH ☒ mm ONLY		REVISE ON CAD ONLY	
												FINISH 仕上付				10 UNDER 未満		±0.2		DRAWN BY & DATE M.NINOMIYA '04/02/19		TITLE: 0.4 B-To-B Rec Assy W/Gde (Hgt=1.5) [Ni Barrier] Embstp Pkg -LEAD FREE-									
												//				10 OVER 30 UNDER 以上 未満		±0.25		CHECKED BY & DATE K.TOJO '04/02/19											
												WIRE RANGE 適用電線範囲				//		30 OVER 以上		±0.3		APPROVED BY & DATE M.SASAO '04/02/19		MOLEX INCORPORATED							
												INS. RANGE 被覆外径			//		ANGLE 角度		±3°		CAD FILENAME SD-54765-031.S03		MATERIAL NO. SEE CHART		DRAWING NO. SD-54765-031		SHEET NO. 3 OF 3		SIZE B		
												THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.																			

8 7 6 5 4 3 2